Issue Details and Description: Ti needs detailed information in order to duplicate the issue on a stand-alone Ti part in the lab. Important: Please provide schematics of the circuit along with measurement results & wave forms separately by email! TI part # OPT3006YMFT (Biamp 262,0831) marked with a "1" on top side of component are failing final test for light sensitivity. The board and component are exposed to a light Source and readings are taken, A passing unit Would show a charge in reading reacting to the light. However, no changes are observed when a fail unit is tested. Components marked with a "O" instead of "1" Work and pass the light sensitivity testing, There have been no other external differentiating factors found to help explain the difference in testing success.

Failure Isolation & Application Information from the Custome	er:
What is the condition of the suspected failing TI part(s)?	Sporadic
Was the observed issue verified on TI part level outside the application?	Yes / No
Did replacing the suspect TI part with a new TI part resolve the issue?	☑Yes / ☐ No
Was the suspect TI part installed onto another passing board causing that board to fail (A-B-A swap)? Means did the failure follow the suspect TI part? This is an essential part of the troubleshooting analysis. Pls ensure this has been performed.	Ves / □ No
Is the suspect TI part used in more than one location on the circuit board?	Yes / No
If yes, how many locations?	
Which locations are causing the issue?	,
Is this a new application?	☐ Yes / ☑ No
When was TI part designed into this application?	
Was the application/design changed or modified recently?	☐ Yes / ☑ No
Did the same issue occur in the past?	Yes / No
If yes, please provide the reference TI QTS# or National PQA#.	

Programmable Products Is the TI part protected by a Security Key Code? Which Firmware Version is used?	☐ Yes / ☑ No
Low-Power RF (Chipcon) Radio Products TI Part Register Settings?	NA
MSP430™ Ultra-Low Power 16-Bit Microcontrollers:	
JTAG access? Security fuse blown? If yes please provide the customer code!	☐ Yes / ☑ No ☐ Yes / ☑ No
In case a FRAM TI part needs to be replaced on an application board the customer must be changed by the de-soldering process. Therefore it is recommended to analyze any wi application board or read out the memory content of the TI part before de-soldering.	be aware that the memory content can rong application behavior directly on the